# **MA3X716** (MA716)

# Silicon epitaxial planar type

#### For switching

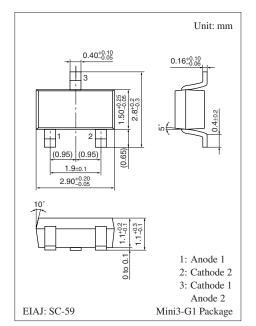
For wave detection

## Features

- Two MA3X704A (MA704A) is contained in one package (series connection)
- Low forward voltage V<sub>F</sub>, optimum for low voltage rectification
- Optimum for high frequency rectification because of its short reverse recovery time  $(t_{rr})$

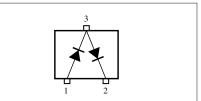
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Parameter		Symbol	Rating	Unit		
Reverse voltage		V <sub>R</sub>	30	V		
Maximum peak reverse voltage		V <sub>RM</sub>	30	V		
Peak forward current	Single	I <sub>FM</sub>	150	mA		
	Series		110			
Forward current	Single	$I_{\rm F}$	30	mA		
	Series		20			
Junction temperature		Tj	125	°C		
Storage temperature		T <sub>stg</sub>	-55 to +125	°C		

#### Absolute Maximum Ratings $T_a = 25^{\circ}C$



### Marking Symbol: M1U

#### Internal Connection



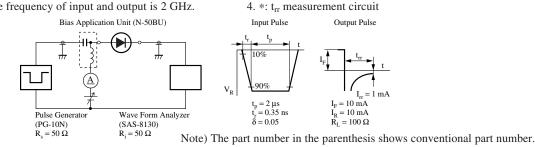
# Electrical Characteristics $T_a = 25^{\circ}C \pm 3^{\circ}C$

Parameter	Symbol	Conditions	Min	Тур	Max	Unit
Forward voltage	V <sub>F1</sub>	$I_F = 1 mA$			0.4	V
	V <sub>F2</sub>	$I_F = 30 \text{ mA}$			1.0	
Reverse current	I <sub>R</sub>	$V_R = 30 V$			1	μΑ
Terminal capacitance	Ct	$V_R = 1 V, f = 1 MHz$		1.5		pF
Reverse recovery time *	t <sub>rr</sub>	$I_F = I_R = 10 \text{ mA}$ $I_{rr} = 1 \text{ mA}, R_L = 100 \Omega$		1.0		ns
Detection efficiency	η	$V_{IN} = 3 V_{(peak)} , f = 30 MHz$ $R_L = 3.9 k\Omega, C_L = 10 pF$		65		%

Note) 1. Measuring methods are based on JAPANESE INDUSTRIAL STANDARD JIS C 7031 measuring methods for diodes.

2. This product is sensitive to electric shock (static electricity, etc.). Due attention must be paid on the charge of a human body and the leakage of current from the operating equipment.

3. Absolute frequency of input and output is 2 GHz.

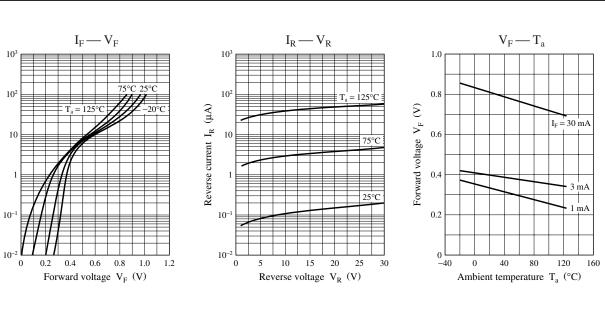


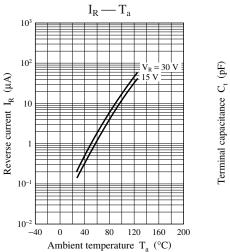
Publication date: February 2005

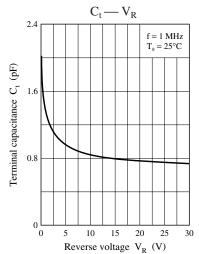
Panasonic

# MA3X716

Forward current  $\,I_{F}\,\,(mA)$ 







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